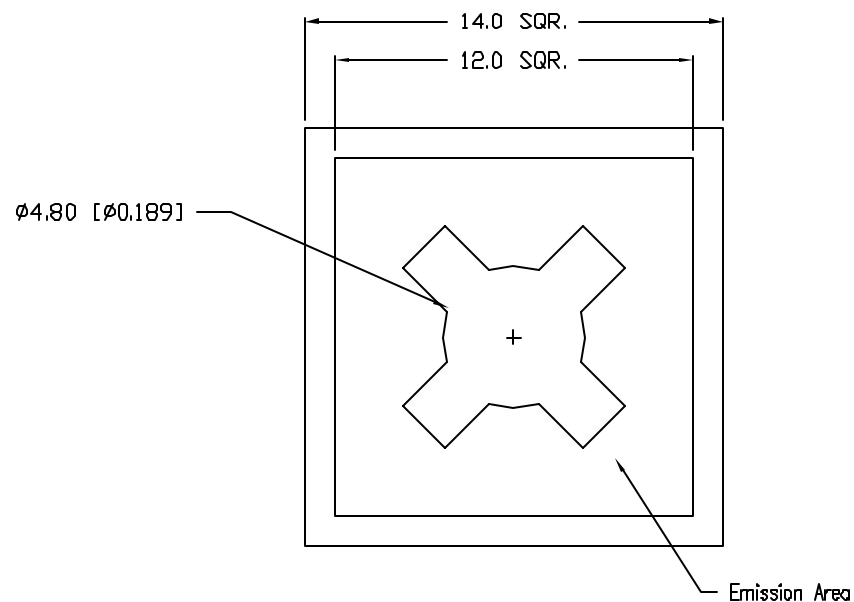


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PART NUMBER

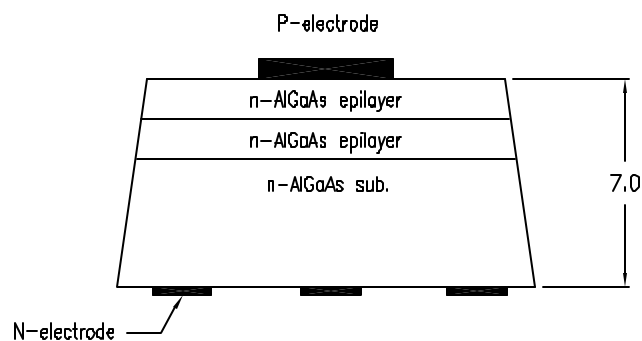
SSD-LX014E870DGPU

REV.



ELECTRO-OPTICAL CHARACTERISTICS:

PARAMETER	SYMBOL	TEST COND	MIN	TYP	MAX	UNITS
FORWARD VOLTAGE	V_f	$I_f=20\text{mA}$		1.4	1.5	V
REVERSE CURRENT	I_r	$V_r=5\text{V}$			10	μA
PEAK WAVELENGTH	λ_p	$I_f=20\text{mA}$		870		nm
SPECTRA HALF-WIDTH	$\Delta\lambda$	$I_f=20\text{mA}$		50		nm
RADIANT POWER	P_o	$I_f=20\text{mA}$	2.5			mW



NOTES:

1. UNITS: mil
2. WIRE BOND METALLIZATION: GOLD.
3. P SIDE UP ON WAFER.

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AlGaAs/AlGaAs 870nm IR CHIP.

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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PAGE: 1 OF 1

SCALE: N/A